

HOUSE AMENDMENTS TO A-ENGROSSED HOUSE BILL 4154

By JOINT COMMITTEE ON WAYS AND MEANS

March 5

1 On page 2 of the printed A-engrossed bill, delete lines 20 through 45 and delete pages 3 through
2 7 and insert:

3 **“SECTION 1. (1) The Higher Education Coordinating Commission shall allocate moneys**
4 **from the Semiconductor Talent Sustaining Fund established in section 2 of this 2024 Act to**
5 **provide education, training and research to assist the semiconductor industry in:**

6 **“(a) Propelling industry innovation and productivity; and**

7 **“(b) Providing careers to residents of this state who receive technical certificates, cre-**
8 **dentials, technical degrees, associate degrees, bachelor’s degrees and graduate-level degrees**
9 **in fields related to semiconductors.**

10 **“(2) When making allocations under this section, the commission shall consider allo-**
11 **cations that:**

12 **“(a) Address the most-demonstrated pressing and long-term needs of the semiconductor**
13 **industry;**

14 **“(b) Advance a more diverse workforce, with a focus on increasing career opportunities**
15 **for historically underrepresented youth and adults;**

16 **“(c) Utilize the information compiled in and recommendations made by the final report**
17 **of the Semiconductor Workforce and Talent Assessment (January, 2024) that was prepared**
18 **for the commission;**

19 **“(d) Facilitate or advance workforce opportunities created by federal or state semicon-**
20 **ductor financial assistance investments;**

21 **“(e) Create new economic growth and pathways to economic opportunity across this**
22 **state; and**

23 **“(f) Consider the priorities of industry consortia established under section 10, chapter 28,**
24 **Oregon Laws 2022, that represent manufacturing and technology sectors.**

25 **“SECTION 2. (1) The Semiconductor Talent Sustaining Fund is established in the State**
26 **Treasury, separate and distinct from the General Fund. Interest earned by the Semiconduc-**
27 **tor Talent Sustaining Fund shall be credited to the fund.**

28 **“(2) Moneys in the Semiconductor Talent Sustaining Fund shall consist of:**

29 **“(a) Amounts donated to the fund from individuals, private organizations and state or**
30 **federal governmental entities;**

31 **“(b) Amounts appropriated or otherwise transferred to the fund by the Legislative As-**
32 **sembly; and**

33 **“(c) Interest earned by the fund.**

34 **“(3) Moneys in the fund are continuously appropriated to the Higher Education Coordi-**
35 **nating Commission for the purposes of supporting the semiconductor industry in the manner**

1 **described in section 1 of this 2024 Act.**

2 **“SECTION 3. Sections 1 and 2 of this 2024 Act are repealed on January 2, 2030.**

3 **“SECTION 4. The Semiconductor Talent Sustaining Fund established under section 2 of**
4 **this 2024 Act is abolished. Any moneys remaining in the fund on the operative date specified**
5 **in section 5 of this 2024 Act shall be transferred to the General Fund for general government**
6 **purposes.**

7 **“SECTION 5. Section 4 of this 2024 Act becomes operative on January 2, 2030.**

8 **“SECTION 6.** Section 1, chapter 25, Oregon Laws 2023, is amended to read:

9 **“Sec. 1.** (1) As used in sections 1 to 6, **chapter 25, Oregon Laws 2023** [of this 2023 Act]:

10 (a) ‘Covered entity’ has the meaning given that term by 15 U.S.C. 4651(2).

11 (b) ‘Covered incentive’ has the meaning given that term by 15 U.S.C. 4651(3).

12 (c) ‘Federal semiconductor financial assistance’ means assistance available under the program
13 established pursuant to 15 U.S.C. 4652(a)(1) **or 15 U.S.C. 4656(c)** for financial assistance to the
14 semiconductor industry.

15 (d) ‘Program grants and loans’ means grants awarded and loans made under the program de-
16 veloped by the Oregon Business Development Department pursuant to this section.

17 (2)(a) The Oregon Business Development Department shall develop a program to award grants
18 and make loans from moneys in the Oregon CHIPS Fund established under section 6, **chapter 25,**
19 **Oregon Laws 2023,** [of this 2023 Act] to businesses applying for federal semiconductor financial
20 assistance.

21 (b)(A) The program shall be administered by the department and the Governor as set forth in
22 this section.

23 (B) Notwithstanding the duties and powers conferred respectively on the department and the
24 Governor under sections 1 to 6, **chapter 25, Oregon Laws 2023** [of this 2023 Act], the department
25 and the Governor may consult each other with respect to any duty or power so conferred.

26 (c) It is the intent of the Legislative Assembly that program grants and loans be treated by the
27 United States Secretary of Commerce as covered incentives for purposes of the federal semicon-
28 ductor financial assistance program.

29 (3)(a) Program grant and loan proceeds may be used solely for:

30 (A) If a business’s application for federal semiconductor financial assistance is approved, ac-
31 tivities undertaken in connection with the federal semiconductor financial assistance program; and

32 (B) Regardless of whether a business’s application for federal semiconductor financial assist-
33 ance is approved:

34 (i) The development of a site for a semiconductor or other advanced manufacturing facility,
35 including, but not limited to, the acquisition and aggregation of land;

36 (ii) Research and development with respect to semiconductors or advanced manufacturing; or

37 (iii) Partnering with institutions of higher education, including, but not limited to, historically
38 Black colleges and universities, career technical training institutions, regional collaborative groups,
39 local workforce development boards as defined in ORS 660.300, programs funded through the federal
40 Workforce Innovation and Opportunity Act (P.L. 113-128) and apprenticeship programs registered
41 with the State Apprenticeship and Training Council for the purpose of workforce development and
42 the creation of training, registered apprenticeship and internship opportunities, with respect to
43 semiconductors or advanced manufacturing.

44 (b) Contractors and subcontractors on construction projects funded by program grant or loan
45 proceeds must pay for such projects a rate of wage that meets or exceeds the greater of:

1 “(A) The prevailing rate of wage for workers in each trade or occupation in each locality as
2 determined by the Commissioner of the Bureau of Labor and Industries under ORS 279C.815; or

3 “(B) The prevailing rate of wage as determined by the United States Secretary of Labor under
4 the Davis-Bacon Act (40 U.S.C. 3141 et seq.).

5 “(4)(a) A business that is a covered entity may apply to the department under section 2, **chapter**
6 **25, Oregon Laws 2023**, [of this 2023 Act] for a program grant or loan.

7 “(b)(A) Except as provided in subparagraph (B) of this paragraph, program grants and loans may
8 not be awarded or made to any applicant in an amount greater than \$50 million.

9 “(B) The Governor may approve a program grant or loan under section 3, **chapter 25, Oregon**
10 **Laws 2023**, [of this 2023 Act] in an amount greater than \$50 million only after having given the
11 Legislative Assembly at least 30 calendar days’ notice of the amount of the program grant or loan
12 the Governor intends to approve.

13 “(c)(A) Program loans:

14 “(i) May be made for a term not to exceed 10 years, as negotiated by the business and, in con-
15 sultation with the Governor, the department; and

16 “(ii) Except as provided in section 5 (3), **chapter 25, Oregon Laws 2023** [of this 2023 Act], shall
17 be made at a zero rate of interest.

18 “(B) All amounts received by the department in repayment of a program loan shall be trans-
19 ferred to the Oregon CHIPS Fund established under section 6, **chapter 25, Oregon Laws 2023** [of
20 this 2023 Act].

21 “(d) Proceeds from a program grant or loan may be distributed in a single payment or in mul-
22 tiple, conditional payments, as specified in the program grant or loan agreement.

23 “(e)(A) Except as provided in paragraph (f) of this subsection, for every \$1 million in program
24 grant or loan proceeds received, the recipient business must, over the period of the grant or loan
25 agreement, generate at least:

26 “(i) If the term of the agreement is not more than five years, \$1.25 million in state and local
27 revenue; or

28 “(ii) If the term of the agreement is more than five years, \$1.5 million in state and local revenue.

29 “(B) The department and the recipient business may specify in the program grant or loan
30 agreement what the term ‘revenue’ includes.

31 “(f) In lieu of the requirement under paragraph (e) of this subsection, a recipient business may
32 instead commit to the creation of new jobs in Oregon:

33 “(A) At least 65 percent of which are permanent, full-time positions; and

34 “(B) That pay on average at least the average median income for the region of this state in
35 which the services will be performed.

36 “(g)(A) In addition to program grants and loans, an application assistance grant, in an amount
37 not to exceed \$50,000, may be awarded to a business whose application is approved under section
38 3, **chapter 25, Oregon Laws 2023** [of this 2023 Act], for the costs of preparing and submitting the
39 business’s application for federal semiconductor financial assistance.

40 “(B) Application assistance grants may be made from moneys in the fund or from any other
41 source of funding available for such purpose to the department or the Governor.

42 “(5) **Program grants receiving federal semiconductor financial assistance under 15 U.S.C.**
43 **4656(c) are exempt from:**

44 “(a) **Subsection (4)(e) and (f) of this section;**

45 “(b) **Section 2 (1)(b)(G), chapter 25, Oregon Laws 2023; and**

1 **“(c) Section 5 (1)(a)(C), chapter 25, Oregon Laws 2023.**
2 **“SECTION 7.** Section 6, chapter 25, Oregon Laws 2023, is amended to read:
3 **“Sec. 6.** (1) The Oregon CHIPS Fund is established in the State Treasury, separate and distinct
4 from the General Fund. Interest earned by the Oregon CHIPS Fund shall be credited to the fund.
5 “(2) Moneys in the fund shall consist of:
6 “(a) Amounts appropriated or otherwise transferred or credited to the fund by the Legislative
7 Assembly;
8 “(b) Earnings received on moneys in the fund; and
9 “(c) Other moneys, or proceeds of property, from any public or private source that are trans-
10 ferred, donated or otherwise credited to the fund.
11 “(3) Moneys in the Oregon CHIPS Fund are continuously appropriated to the Oregon Business
12 Development Department for the following purposes:
13 “(a) Paying the actual costs incurred by the department in developing and administering
14 sections 1 to 6, **chapter 25, Oregon Laws 2023** [*of this 2023 Act*]; [*and*]
15 “(b) Carrying out the provisions of sections 1 to 6, **chapter 25, Oregon Laws 2023** [*of this 2023*
16 *Act*]; **and**
17 **“(c) Transferring moneys to the Semiconductor Talent Sustaining Fund established under**
18 **section 2 of this 2024 Act.**
19 “(4) Moneys in the Oregon CHIPS Fund on June 30, 2023, shall be retained in the fund, and used
20 for the purposes set forth in subsection (3) of this section, until June 30, 2025.
21 “(5) Any moneys remaining in the Oregon CHIPS Fund on June 30, 2025, shall be transferred
22 to the General Fund.
23 **“SECTION 8. This 2024 Act takes effect on the 91st day after the date on which the 2024**
24 **regular session of the Eighty-second Legislative Assembly adjourns sine die.”**
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